Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	73955	((form$5 or generat$3 or produc$3 or mak$3 or manufactur$3 or creat$3 or fabricat$3) with (via or hole$1 or opening$1)) and (glass with (wafer$1 or substrate$1))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 16:36
L3	185	L2 and polysilicon and (sandblast$3 or (sand adj blast$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 15:43
L4	78	L3 and ((wet adj3 etch$3) or (etch$3 near3 solution) or (etch$3 adj3 bath) or (liquid adj3 etch$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 15:44
L5	76	L3 and (polysilicon same glass)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 15:20
L6	50	L5 not L4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 15:19
L7	64	L3 and (polysilicon with glass)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 15:20
L8	40	L7 not L4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 15:21
L10	2244	L2 and MEMS	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 15:43
L11	43	L10 and (sandblast$3 or (sand adj blast$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 15:44